# **Bottom-Contact Pentacene Thin-Film Transistors with Threshold Voltages Controlled by Oxygen Plasma Treatment**

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### Abstract

Threshold voltage control by oxygen plasma treatment has been applied to bottom-contact pentacene thin-film transistors (TFTs). The threshold voltage in the pentacene TFT shifted to positive gate voltages with the plasma treatment time as well as that in a top-contact TFT. Although the long-time plasma treatment led to increase in the contact resistance, the plasma treatment time for threshold voltage shifts of several voltages had no large influence on the field-effect mobility in the saturation regime.

## 1. Introduction

Organic thin-film transistors (TFTs) have attracted much attention because of their applications to logic circuits and flat panel displays [1-3]. Threshold voltage control is an important issue for the application of organic TFTs. Some approaches have been attempted for the threshold voltage control [4-7].

We have used oxygen plasma treatment to the gate dielectrics for the control [8-11]. The threshold voltage shifts to positive gate voltage with increase in the treatment time. Thus, the threshold voltages can be controlled by changing the treatment time. Since the fabrication process has an advantage that it does not require additional structures, it is straightforwardly applied to logic circuits. In fact, we demonstrated operation of a ring oscillator consisting of top-contact pentacene TFTs with different threshold voltage [11]. However, the top-contact configuration limited the operational frequency to about 300 Hz because of the long-channel length. It is expected that the threshold voltage control is applied for bottom-contact organic TFTs with short-channel toward demonstration lengths of high-frequency operation.

In this study, we fabricated bottom-contact pentacene TFTs with gate dielectrics treated by oxygen plasma to confirm whether the method of threshold voltage control is applicable to bottom-contact organic TFTs. The current-voltage characteristics and contact resistance were measured to evaluate the method.

# 2. Experimental

Figure 1 shows the fabrication process for pentacene TFTs investigated in this study. The pentacene TFT was fabricated on a highly-doped Si substrate with a 90-nm-thick thermal oxide layer, which had a unit area capacitance of  $36.9 \text{ nF/cm}^2$ . The drain/source electrode was patterned by

photolithography and lift-off process. The use of AuNi serving as an adhesive layer contributes to suppress contact resistance [12]. The substrate with the patterned electrode was exposed to UV/ozone for  $t_{\rm U} = 15$  min, to O<sub>2</sub> plasma for a time of  $t_{\rm P}$ , and then to hexamethyldisilazane (HMDS) vapor. After the treatment, the drain/source electrode was modified with pentafluorobenzenethiol (PFBT). Finally, a 45-nm-thick pentacene layer was deposited through a shadow mask to form channel region. The channel width (W) was 1 mm and the channel length (L) was in the range of 4 to 40 µm. The characteristics were measured in a dry-nitrogen-filled glovebox.



- 2. Resist patterning
- 3. Au<sub>0.95</sub>Ni<sub>0.05</sub>/Au (3/25 nm) deposition 4. Lift-off & cleaning
- 5. UV/ozone treatment for tu
- 6. O<sub>2</sub> plasma treatment for  $\tilde{t}_{\rm P}$



Fig. 1 Fabrication process of pentacene TFTs.

#### 3. Results

Figure 2 shows the drain current  $(I_D)$  versus gate voltage  $(V_{\rm G})$  characteristics of pentacene TFTs with  $L = 4 \ \mu m$  for different  $t_P$  at a drain voltage ( $V_D$ ) of -20 V. The  $I_D$ - $V_G$ curves shifted to positive gate voltage with increase in  $t_{\rm P}$ .



Fig. 2 Transfer characteristics of pentacene TFTs with  $L = 4 \mu m$  for  $t_{\rm P} = 0, 30, 60, \text{ and } 120 \text{ s at } V_{\rm D} = -20 \text{ V}.$ 

Figure 3 shows the threshold voltages  $(V_{\text{TH}})$  estimated from the  $|I_D|^{1/2}$ - $V_G$  characteristics. The relationship between  $V_{\rm TH}$  and L for a time of  $t_{\rm P}$  shown in Fig. 3 indicates that the change of L has no large influence on the threshold voltage shift. Thus, we can discuss the change in the threshold voltage on the basis of pentacene TFTs with a certain L. Figure 3(b) shows the  $V_{\rm TH}$  versus  $t_{\rm p}$  of bottom-contact pentacene TFTs with  $L = 4 \ \mu m$  fabricated in this work and of top-contact pentacene TFTs with  $L = 100 \ \mu m$  reported in Ref. [8]. The  $V_{\rm TH}$  linearly increases with  $t_{\rm P}$  for both cases. However, the  $V_{\rm TH}$  in this work is more sensitive to  $t_{\rm P}$  as compared to that in previous work. The different procedure of the surface treatment may cause the difference of the sensitivity. Although UV/ozone treatment was performed before O2 plasma treatment in this study, no UV/ozone treatment was performed in previous work.



Fig. 3 (a)  $V_{\text{TH}}$  versus *L* of pentacene TFTs for different  $t_{\text{P}}$ . (b)  $V_{\text{TH}}$  versus  $t_{\text{P}}$  of pentacene TFTs in this work and in previous work.

To investigate the influence of  $O_2$  plasma treatment on the drain/source electrode of the TFT, we estimated the contact resistance ( $R_C$ ) using transfer line method. The channel-length normalized contact resistance increases with  $t_P$  as seen in Fig. 4. This indicates that  $O_2$  plasma treatment causes the increase in contact resistance. The origin of the increase may relate to modification of drain/source electrodes after  $O_2$  plasma treatment. The detail has been under investigation. The importance is whether the increase of the contact resistance leads to degradation of TFT performance.



Fig. 4 Dependence of  $R_C W$  on  $t_P$  for pentacene TFTs.



Fig. 5 Channel-length dependence of  $\mu_{sat}$  in pentacene TFTs.

Figure 5 shows the field-effect mobility in the saturation regime ( $\mu_{sat}$ ) in pentacene TFTs for different  $t_P$ . Although the  $\mu_{sat}$  for  $t_P = 60$  and 120 s is lower than that for  $t_P = 0$ , the  $\mu_{sat}$  values of 0.65-0.71 cm<sup>2</sup> V<sup>-1</sup> s<sup>-1</sup> for  $t_P = 30$  s is close to that of 0.70-0.73 cm<sup>2</sup> V<sup>-1</sup> s<sup>-1</sup> for  $t_P = 0$ . This indicates that short O<sub>2</sub> plasma treatment has no large influence on  $\mu_{sat}$ . This is probably because the contact resistance for the  $t_P$  is significantly low under operation in the saturation regime.

## 4. Conclusions

In conclusion, we demonstrated threshold voltage control of bottom-contact pentacene TFTs using  $O_2$  plasma treatment. As a result, the plasma treatment time for threshold voltage shifts of several voltages had no large influence on the field-effect mobility in the saturation regime. Thus, the method of threshold voltage control is useful for application of short-channel, bottom-contact organic TFTs to logic circuit operating at a high-frequency.

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#### References

- T. Sekitani and T. Someya, Jpn. J. Appl. Phys. 51 (2012) 100001.
- [2] H. T. Yi, M. M. Payne, J. E. Anthony, and V. Podzorov, Nat. Commun. 3 (2012) 1259.
- [3] D. M. Taylor, Jpn. J. Appl. Phys. 55 (2016) 02BA01.
- [4] R. Schroeder, L. A. Majewski, and M. Grell, Appl. Phys. Lett. 83 (2003) 3201.
- [5] S. Kobayashi, T. Nishikawa, T. Takenobu, S. Mori, T. Shimoda, T. Mitani, H. Shimotani, N. Yoshimoto, S. Ogawa, and Y. Iwasa, Nat. Mater. 3 (2004) 317.
- [6] U. Zschieschang, F. Ante, M. Schlörholz, M. Schmidt, K. Kern, and H. Klauk, Adv. Mater. 22 (2010) 4489.
- [7] S. Iba, T. Sekitani, Y. Kato, T. Someya, H. Kawaguchi, M. Takamiya, T. Sakurai, and S. Takagi, Appl. Phys. Lett. 87 (2005) 023509.
- [8] Y. Kimura, M. Kitamura, A. Kitani, and Y. Arakawa, Jpn. J. Appl. Phys. 55 (2016) 02BB14.
- [9] A. Kitani, Y. Kimura, M. Kitamura, and Y. Arakawa, Jpn. J. Appl. Phys. 55 (2016) 03DC03.
- [10] H. Takahashi, Y. Hanafusa, Y. Kimura, and M. Kitamura, Jpn. J. Appl. Phys. 57 (2018) 03EH03.
- [11] H. Takahashi, M. Kitamura, Y. Hattori, and Y. Kimura, Jpn. J. Appl. Phys. 58 (2019) SBBJ04.
- [12] M. Kitamura, Y. Kuzumoto, W. Kang, S. Aomori, and Y. Arakawa, Appl. Phys. Lett. 97 (2010) 033306.